

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	CHIEW LAN TAI	02/20/2014
	KIN CHUNG AU	02/06/2014
	HONGBO FU	02/07/2014
RECEIVING PARTY DATA		
Name:	THE HONG KONG UNIVERSITY OF SCIENCE AND TECHNOLOGY	
Street Address:	CLEAR WATER BAY	
City:	KOWLOON	
State/Country:	HONG KONG	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14347230
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ATTORNEY DOCKET NUMBER:	TTC.PA.0487/HKSTP157WOUS	
NAME OF SUBMITTER:	THOMAS E. WATSON	
SIGNATURE:	/Thomas E. Watson/	
DATE SIGNED:	03/25/2014	
Total Attachments: 3		
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ASSIGNMENT

- (1) Whereas Chiew Lan TAI, Kin Chung AU and Hongbo FU have invented certain new and useful inventions, hereinafter referred to as "the invention".

In consideration of the sum of one U.S. dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I [we], the undersigned inventor[s], hereinafter referred to as "ASSIGNOR(S)":

Given Name:	Chiew Lan TAI		
Residence:	Kowloon, Hong Kong, China	Citizenship:	Malaysia
Mailing Address:	Flat 2A, Tower 5, Senior Staff Quarter, The Hong Kong University of Science and Technology		
	Clear Water Bay Road, Kowloon, Hong Kong, China		

Given Name:	Kin Chung AU		
Residence:	Shau Ki Wan, Hong Kong, China	Citizenship:	Hong Kong, China
Mailing Address:	Flat A, 3/F, 50 Hoi An Street		
	Shau Ki Wan, Hong Kong, China		

Given Name:	Hongbo FU		
Residence:	New Territories, Hong Kong, China	Citizenship:	China
Mailing Address:	18C, Tower 2, Lake Silver, 599 Sai Sha Road, Ma On Shan, Sha Tin		
	New Territories, Hong Kong, China		

hereby sell, assign, transfer, and convey unto:

The Hong Kong University of Science and Technology

a Hong Kong educational and research institution, having an address at Clear Water Bay, Kowloon, Hong Kong ("Assignee"), and its successors, assigns and legal representatives, all right, title, and interest that exist today and may exist in the future in and to said invention and application, including but not limited to any and all of the following (collectively, "Patent Rights"):

(a) The U.S. Patent Application ("Application") entitled:

**SYSTEM AND METHOD FOR CONSTRAINED MANIPULATIONS OF
3D OBJECTS BY MULTITOUCH INPUTS**

which was filed as

U.S. Patent Application No. 14/347,230,

Filed 03/25/2014 and listing the above named persons as inventors;
Date

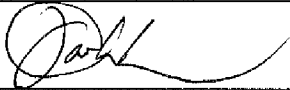
which has been executed by the undersigned prior hereto or concurrently herewith;

- (b) any and all patents and patent applications (i) to which the Application directly or indirectly claims priority, (ii) for which the Application directly or indirectly forms a basis for priority, and/or (iii) that were co-owned applications that incorporate by reference, or are incorporated by reference into, the Application;
- (c) any and all reissue applications, reexaminations, extensions, continuation applications, continuation-in-part applications, continuing prosecution applications, requests for continued examination, divisional applications, substitute applications, renewal applications, registrations, and any and all other patent applications that have been or shall be filed in the U.S. relating to any item in any of the foregoing categories (a) and (b);
- (d) any and all patents (including, without limitation, reissues, continuations, continuations in part and divisions) issuing from or relating to any of the foregoing categories (a) through (c);
- (e) any and all foreign patents, foreign patent applications, and foreign counterparts relating to any item in any of the foregoing categories (a) through (d), including, without limitation, certificates of invention, utility models, industrial design protection, design patent protection, and other governmental grants or issuances;
- (f) any and all items in any of the foregoing in categories (a) through (e) whether or not claims in any of the foregoing have been rejected, withdrawn, cancelled, or the like;
- (g) any and all inventions, invention disclosures, improvements, and discoveries described in any item in any of the foregoing categories (a) through (e) and all other rights arising out of such inventions, invention disclosures, improvements, and discoveries;
- (h) any and all rights to apply in any or all countries of the world for patents, certificates of invention, utility models, industrial design protections, design patent protections, or other governmental grants or issuances of any type related to any item in any of the foregoing categories (a) through (e) and (g), including, without limitation, under the Paris Convention for the Protection of Industrial Property, the International Patent Cooperation Treaty, or any other convention, treaty, agreement, or understanding;
- (i) any and all causes of action (whether known or unknown or whether currently pending, filed, or otherwise) and other enforcement rights under, or on account of, any item in any of the foregoing categories (a) through (e), (g), and (h), including, without limitation, all causes of action and other enforcement rights for (i) damages, (ii) injunctive relief, and (iii) any other remedies of any kind for past, current, and future infringement; and
- (j) any and all rights to collect royalties and other payments under or on account of any item in any of the foregoing categories (a) through (e) and (g) through (i).

- (2) I [we] agree to, at the reasonable request of ASSIGNEE and without demanding any further consideration therefore, do all things necessary, proper, or advisable, including without limitation, the execution, acknowledgment, and recordation of specific assignments, oaths, declarations, and other documents on a country-by-country basis, to assist ASSIGNEE in obtaining, perfecting, sustaining, and/or enforcing the Patent Rights. Such assistance will include providing prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, powers of attorney, specifications, declarations or other papers, and other assistance reasonably necessary for filing patent applications, complying with any duty of disclosure, and conducting prosecution, reexamination, reissue, interference or other priority proceedings, opposition proceedings, cancellation proceedings, public use proceedings, infringement or other court actions and the like with respect to the Patent Rights. With prior written approval by ASSIGNEE, ASSIGNEE will pay ASSIGNOR(S)' reasonable costs and expenses.
- (3) I [we] agree that said ASSIGNEE may apply for and receive patent or patents for said Patent Rights in its own name, and hereby authorize the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models or other governmental grants or issuances that may be granted upon any of the Patent Rights in the name of ASSIGNEE, as the ASSIGNEE to the entire interest therein.
- (4) I [we] covenant that no assignment, grant, mortgage, license, or other agreement affecting the Patent Rights has been made to others or will be made to others, and that full right to convey the Patent Rights as herein expressed is possessed.
- (5) I [we] hereby authorize and request the attorneys Turocy & Watson, LLP of Cleveland, OH and Seattle, WA to insert in the spaces provided above the filing date, application number, and attorney docket number of said application when known.
- (6) I [we] agree that the terms and conditions of this Assignment of Patent Rights will inure to the benefit of ASSIGNEE, its successors, assigns, and other legal representatives and will be binding upon the undersigned.

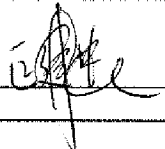
Inventor[s]:

Inventor's Name: Chiew Lan TAI

Inventor's Signature: 

Date 20 Feb 2014

Inventor's Name: Kin Chung AU

Inventor's Signature: 

Date 6 Feb 2014

Inventor's Name: Hongbo FU

Inventor's Signature: 

Date 7 Feb 2014